Special Issue

Multifunctional Nanomaterials: Processing and Applications

Message from the Guest Editor

This Special Issue will publish articles associated with the 5th International Conference on Materials Science, Engineering, and Technology, which is being held on February 26-28, 2024, in Singapore.

We aim to bring together scientists, researchers, engineers, and professionals from all over the world to share their ideas, most advanced developments, findings, and novel scientific and technical knowledge in the field of materials science. The Special Issue of Micromachines will not only serve as a platform to further assist research dissemination but also facilitate the implementation of research into practice.

We cordially invite you to submit your manuscript to this Special Issue. In addition, papers by those who did not attend this meeting are also welcome.

Guest Editor

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Deadline for manuscript submissions

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You are invited to contribute research articles or comprehensive reviews for consideration and publication in *Micromachines* (ISSN 2072-666X). *Micromachines* is published in the open access format. Research articles, reviews and other contents are released on the internet immediately after acceptance. The scientific community and the general public have unlimited free access to the content as soon as it is published. As an open access journal, *Micromachines* is supported by the authors or their institutes by payment of article processing charges (APC) for accepted papers. We are pleased to welcome you as our authors.

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